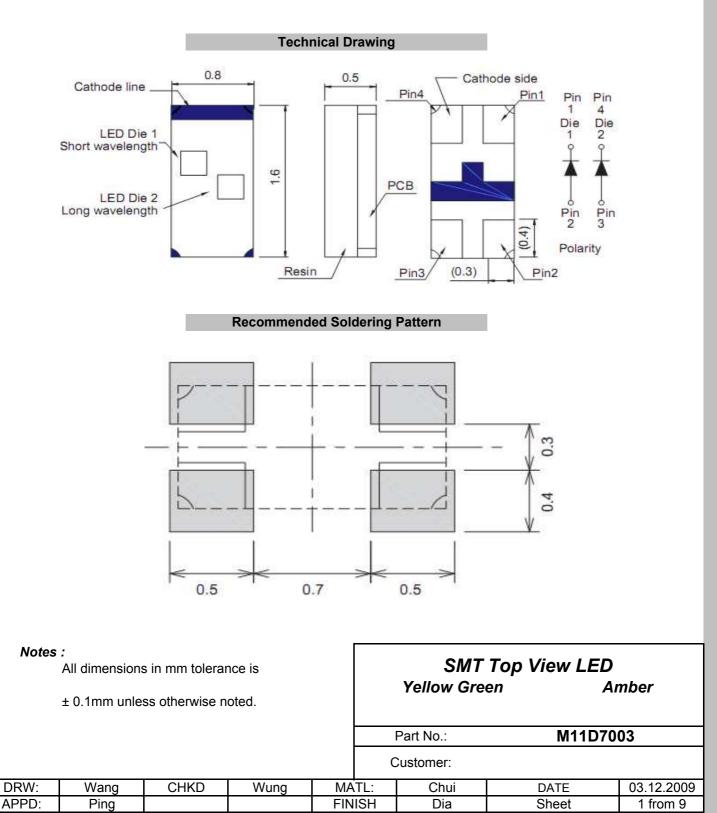




Applications



Copyright by EDCON-COMPONENTS
www.edcon-components.com





Absolute Maximum Ratings

Ta=25°C

Item	Symbol	AllnGaP	Unit
Power Dissipation	P _D	72	mW
DC Forward Current	I _F	30	mA
Plused Forward Current	I _{FP} *	100	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{OP}	-30 to 80	°C
Storage Temperature	T _{ST}	-40 to 85	°C

* 0.1 msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

I_F=20mA Ta=25°C

Ermitting Color		Yellow Green	Amber		
Material		AllnGaP	AllnGaP		
Forward Voltage	typ.	2.0	1.9	V _F	
Forward voltage	max.	2.4	2.4	V _F	
Wavelength	λD	573	605	nm	
-	λP	574	609	nm	
typ.	Δλ	20	17	nm	
Color Temperature	min.			K	
	max.			K	
Luminous Intensity *	min.	36	40	mcd	
Lummous intensity	typ.	90	90	mcd	
Reverse Current	max.			μA	
Viewing Angle	2Θ1/2		140		

* Per NIST standards

CHKD

	I	г								
		SMT Top View LED								
		Yellow Green Amber								
			Part No.:	M11D70	03					
		C	Customer:							
Wung	MA	TL:	Chui	DATE	03.12.2009					
	FIN	ISH	Dia	Sheet	2 from 9					
Copyright by EDCON-COMPONENTS										

Wang

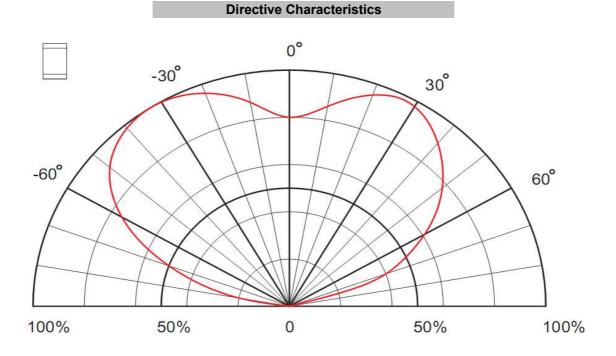
Ping

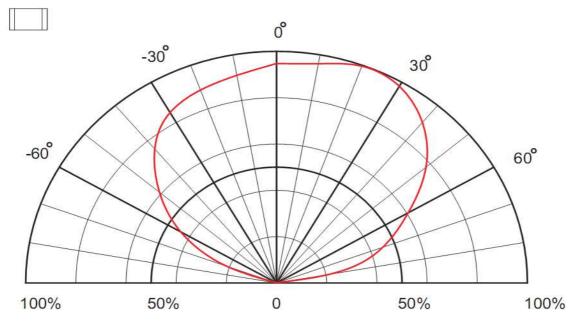
DRW:

APPD:









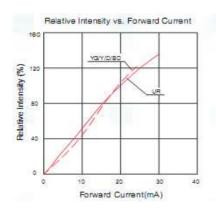
					SMT Top View LED Yellow Green Amber Part No.: M11D7003			
					Customer:			
DRW:	Wang	CHKD	Wung	MAT	L:	Chui	DATE	03.12.2009
APPD:	Ping			FINIS	SH	Dia	Sheet	3 from 9
			Copyright by	EDCON-	COMP	ONENTS		

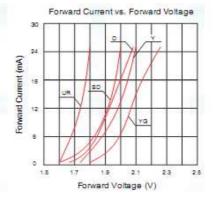
www.edcon-components.com

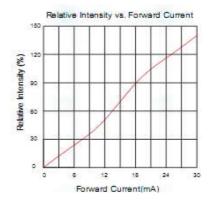


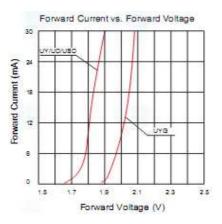


Curvs

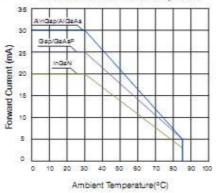












			-									
				SMT Top View LED								
				Yellow Green Amber								
					Part No.:	M11D70	03					
				C	Customer:							
Wang	CHKD	Wung	MA	TL:	Chui	DATE	03.12.2009					
Ping			FINISH		Dia	Sheet	4 from 9					

www.edcon-components.com

DRW: APPD:

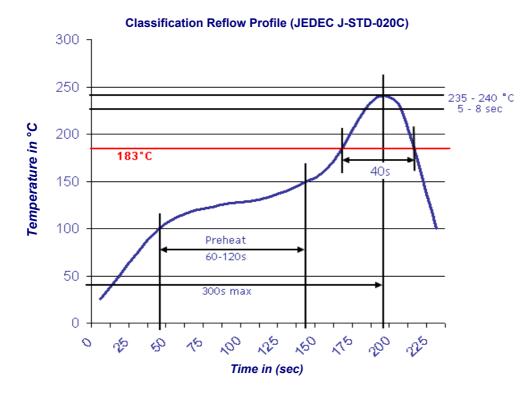
Copyright by EDCON-COMPONENTS





Solder Condition

Lead Free Solder

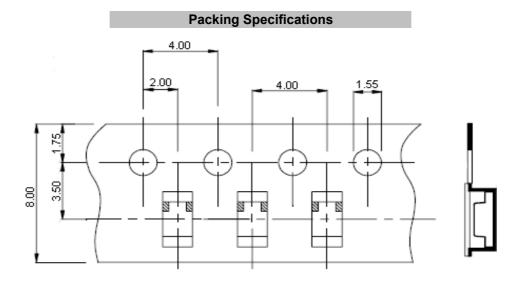


					SMT Top View LED Yellow Green Amber			
						Part No.:	M11D70	003
					Customer:			
DRW:	Wang	CHKD	Wung	MA	TL:	Chui	DATE	03.12.2009
APPD:	Ping			FINI	ISH	Dia	Sheet	5 from 9
			Copyright by	EDCON	I-COMF	PONENTS		

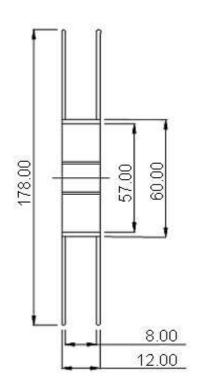
www.edcon-components.com

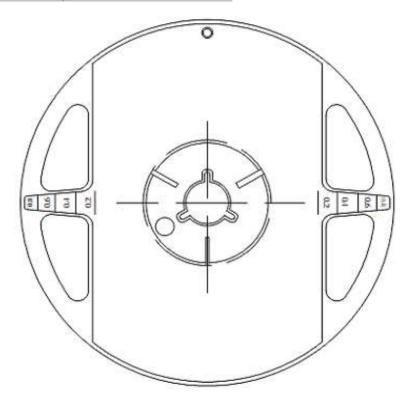






Reel Specifications





					SMT Top View LED Yellow Green Amber Part No.: M11D7003		
					Customer:		
DRW:	Wang	CHKD	Wung	MATL:	Chui	DATE	03.12.2009
APPD:	Ping			FINISH	Dia	Sheet	6 from 9
			Copyright by	EDCON-CO	OMPONENTS		

www.edcon-components.com

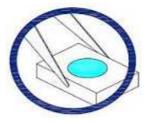




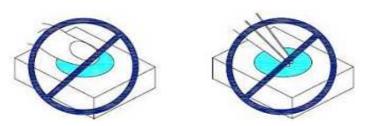
Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



	SMT Top View LED								
		Yellow Gree	reen Amber						
		Part No.:	M11D	7003					
	C	Customer:							
MA	MATL: Chui		DATE	03.12.2009					
FIN	FINISH Dia		Sheet	7 from 9					

Wang

Ping

CHKD

Wung

DRW:

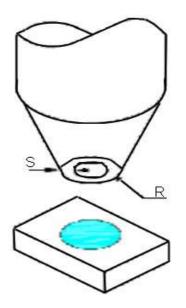
APPD:

Copyright by EDCON-COMPONENTS





- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



		SMT Top View LED Yellow Green Amber						
			Part No.:	M11D70	M11D7003			
		C	Customer:					
Wung	MA	TL:	Chui	DATE	03.12.2009			
	FIN	ISH	Dia	Sheet	8 from 9			
Copyright by EDCON-COMPONENTS								

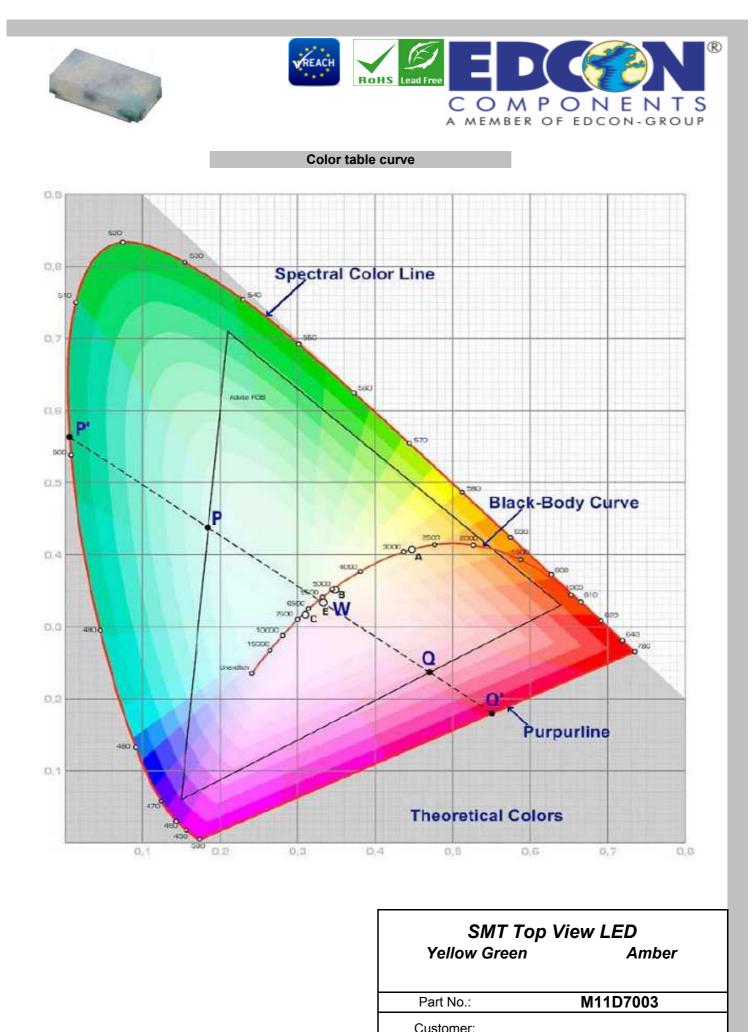
Wang

Ping

CHKD

DRW:

APPD:



					o dotomon.		
DRW:	Wang	CHKD	Wung	MATL:	Chui	DATE	03.12.2009
APPD:	Ping			FINISH	Dia	Sheet	9 from 9
			Copyright by	EDCON-CO	MPONENTS		

www.edcon-components.com